DATA SHEET

74F113
Dual J-K negative edge-triggered flip-flops without reset

Product specification

1991 Feb 14

IC15 Data Handbook

Philips
Semiconductors

PHILIPS

PHILIPS

Dual J-K negative edge-triggered flip-flops without reset

74F113

FEATURE

- Industrial temperature range available (−40°C to +85°C)

DESCRIPTION

The 74F113, dual negative edge-triggered JK-type flip-flop, features individual J, K, clock ($\overline{CP}$), set ($\overline{SD}$) inputs, true and complementary outputs. The asynchronous $\overline{SD}$ input, when low, forces the outputs to the steady state levels as shown in the function table regardless of the level at the other inputs.

A high level on the clock ($\overline{CP}$) input enables the J and K inputs and data will be accepted. The logic levels at the J and K inputs may be allowed to change while the $\overline{CP}$ is high and flip-flop will perform according to the function table as long as minimum setup and hold times are observed. Output changes are initiated by the high-to-low transition of the $\overline{CP}$.

PIN CONFIGURATION

$\overline{CP}0$	1	14	V_{CC}
K0	2	13	$\overline{CP}1$
J0	3	12	K1
$\overline{SD}0$	4	11	J1
Q0	5	10	$\overline{SD}1$
$\overline{Q}0$	6	9	Q1
GND	7	8	$\overline{Q}1$

SF00140
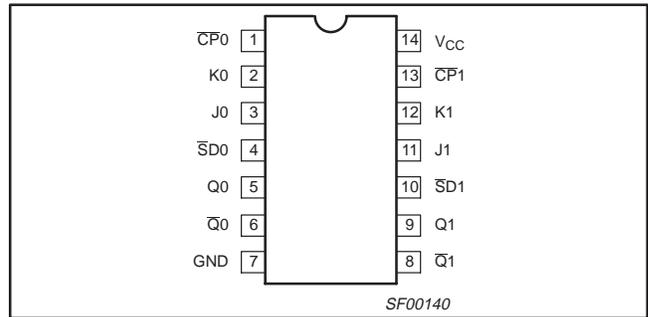
TYPE	TYPICAL f_{max}	TYPICAL SUPPLY CURRENT (TOTAL)
74F113	100MHz	15mA

ORDERING INFORMATION

DESCRIPTION	ORDER CODE		PKG. DWG. #
	COMMERCIAL RANGE $V_{CC} = 5V \pm 10\%$, $T_{amb} = 0°C$ to $+70°C$	INDUSTRIAL RANGE $V_{CC} = 5V \pm 10\%$, $T_{amb} = -40°C$ to $+85°C$	
14-pin plastic DIP	N74F113N	I74F113N	SOT27–1
14-pin plastic SO	N74F113D	I74F113D	SOT108–1

INPUT AND OUTPUT LOADING AND FAN-OUT TABLE

PINS	DESCRIPTION	74F (U.L.) HIGH/LOW	LOAD VALUE HIGH/LOW
J0, J1	J inputs	1.0/1.0	20μA/0.6mA
K0, K1	K inputs	1.0/1.0	20μA/0.6mA
$\overline{CP}0$, $\overline{CP}1$	Clock inputs (active falling edge)	1.0/4.0	20μA/2.4mA
$\overline{SD}0$, $\overline{SD}1$	Set inputs (active low)	1.0/5.0	20μA/3.0mA
Q0, Q1, $\overline{Q}0$, $\overline{Q}1$	Data outputs	50/33	1.0mA/20mA

NOTE:

One (1.0) FAST unit load is defined as: 20μA in the High state and 0.6mA in the Low state.

LOGIC SYMBOL

V_{CC} = Pin 14
GND = Pin 7

SF00141

IEC/IEEE SYMBOL

SF00142
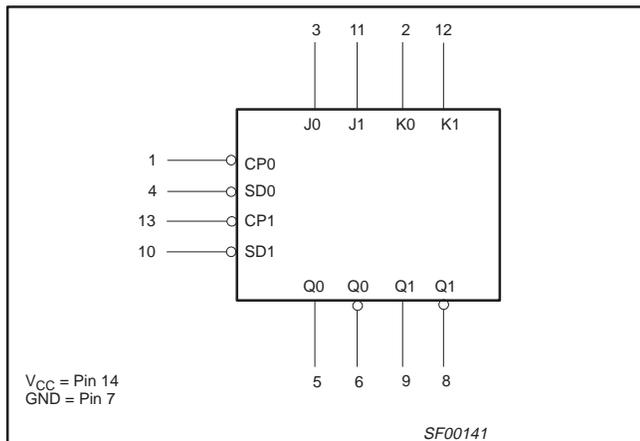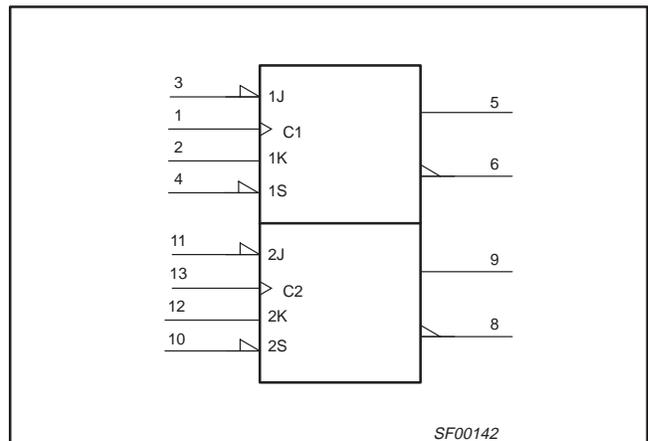
Dual J-K negative edge-triggered flip-flops without reset

74F113

LOGIC DIAGRAM

Q 5, 9

$\overline{SD}$ 4, 10

K 2, 12

6, 8 $\overline{Q}$

3, 11 J

V_{CC} = Pin 14
GND = Pin 7

1, 13
$\overline{CP}$

SF00143
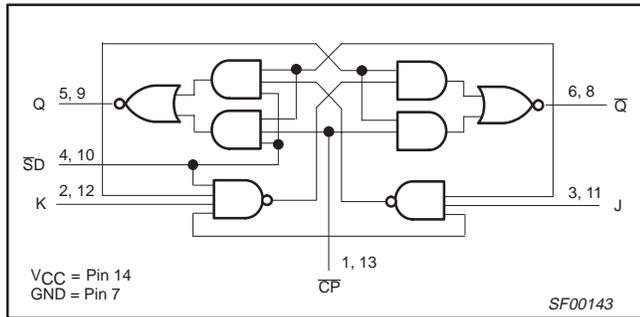
FUNCTION TABLE

INPUTS				OUTPUTS		OPERATING MODE
$\overline{SD}$	$\overline{CP}$	J	K	Q	$\overline{Q}$	
L	X	X	X	H	L	Asynchronous set
H	↓	h	h	$\overline{q}$	q	Toggle
H	↓	h	l	H	L	Load "1" (set)
H	↓	l	h	L	H	Load "0" (reset)
H	↓	l	l	q	$\overline{q}$	Hold 'no change"

NOTES:
H = High-voltage level
h = High-voltage level one setup time prior to high-to-low
clock transition
L = Low-voltage level
l = Low-voltage level one setup time prior to high-to-low clock
transition
q = Lower case indicate the state of the referenced output
prior to the high-to-low clock transition
X = Don't care
↓ = high-to-low clock transition

ABSOLUTE MAXIMUM RATINGS

(Operation beyond the limits set forth in this table may impair the useful life of the device.
Unless otherwise noted these limits are over the operating free-air temperature range.)

SYMBOL	PARAMETER		RATING	UNIT
V_{CC}	Supply voltage		−0.5 to +7.0	V
V_{IN}	Input voltage		−0.5 to +7.0	V
I_{IN}	Input current		−30 to +5	mA
V_{OUT}	Voltage applied to output in High output state		−0.5 to V_{CC}	V
I_{OUT}	Current applied to output in Low output state		40	mA
T_{amb}	Operating free-air temperature range	Commercial range	0 to +70	°C
		Industrial range	−40 to +85	°C
T_{stg}	Storage temperature range		−65 to +150	°C

RECOMMENDED OPERATING CONDITIONS

SYMBOL	PARAMETER		LIMITS			UNIT
			MIN	NOM	MAX	
V_{CC}	Supply voltage		4.5	5.0	5.5	V
V_{IH}	High-level input voltage		2.0			V
V_{IL}	Low-level input voltage				0.8	V
I_{IK}	Input clamp current				−18	mA
I_{OH}	High-level output current				−1	mA
I_{OL}	Low-level output current				20	mA
T_{amb}	Operating free-air temperature range	Commercial range	0		+70	°C
		Industrial range	−40		+85	°C

Dual J-K negative edge-triggered flip-flops without reset

74F113

DC ELECTRICAL CHARACTERISTICS

(Over recommended operating free-air temperature range unless otherwise noted.)

SYMBOL	PARAMETER	TEST CONDITIONS[1]			LIMITS			UNIT
					MIN	TYP[2]	MAX	
V_{OH}	High-level output voltage	V_{CC} = MIN, V_{IL} = MAX, V_{IH} = MIN	I_{OH} = MAX	±10%V_{CC}	2.5			V
				±5%V_{CC}	2.7	3.4		V
V_{OL}	Low-level output voltage	V_{CC} = MIN, V_{IL} = MAX, V_{IH} = MIN	I_{OL} = MAX	±10%V_{CC}		0.30	0.50	V
				±5%V_{CC}		0.30	0.50	V
V_{IK}	Input clamp voltage	V_{CC} = MIN, I_I = I_{IK}				−0.73	−1.2	V
I_I	Input current at maximum input voltage	V_{CC} = MAX, V_I = 7.0V					100	μA
I_{IH}	High-level input current	V_{CC} = MAX, V_I = 2.7V					20	μA
I_{IL}	Low-level input current	Jn, Kn	V_{CC} = MAX, V_I = 0.5V				−0.6	mA
		$\overline{CP}n$					−2.4	mA
		$\overline{SD}n$					−3.0	mA
I_{OS}	Short-circuit output current[3]	V_{CC} = MAX			-60		−150	mA
I_{CC}	Supply current[4] (total)	V_{CC} = MAX				15	21	mA

NOTES:
1. For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions for the applicable type.
2. All typical values are at V_{CC} = 5V, T_{amb} = 25°C.
3. Not more than one output should be shorted at a time. For testing I_{OS}, the use of high-speed test apparatus and/or sample-and-hold techniques are preferable in order to minimize internal heating and more accurately reflect operational values. Otherwise, prolonged shorting of a high output may raise the chip temperature well above normal and thereby cause invalid readings in other parameter tests. In any sequence of parameter tests, I_{OS} tests should be performed last.
4. Measure I_{CC} with the clock input grounded and all outputs open, then with Q and $\overline{Q}$ outputs high in turn.

AC ELECTRICAL CHARACTERISTICS

SYMBOL	PARAMETER	TEST CONDITION	LIMITS							UNIT
			V_{CC} = +5.0V T_{amb} = +25°C C_L = 50pF R_L = 500Ω			V_{CC} = +5.0V ± 10% T_{amb} = 0°C to +70°C C_L = 50pF R_L = 500Ω		V_{CC} = +5.0V ± 10% T_{amb} = −40°C to +85°C C_L = 50pF R_L = 500Ω		
			MIN	TYP	MAX	MIN	MAX	MIN	MAX	
f_{max}	Maximum clock frequency	Waveform 1	85	100		80		80		ns
t_{PLH} t_{PHL}	Propagation delay CPn to Qn or $\overline{Q}$n	Waveform 1	2.0 2.0	4.0 4.0	6.0 6.0	2.0 2.0	7.0 7.0	2.0 2.0	7.5 7.0	ns
t_{PLH} t_{PHL}	Propagation delay $\overline{SD}n$, to Qn or $\overline{Q}$n	Waveform 2	2.0 2.0	4.5 4.5	6.5 6.5	2.0 2.0	7.5 7.5	2.0 2.0	8.0 7.5	ns

AC SETUP REQUIREMENTS

| SYMBOL	PARAMETER	TEST CONDITION	LIMITS							UNIT
			V_{CC} = +5.0V T_{amb} = +25°C C_L = 50pF R_L = 500Ω			V_{CC} = +5.0V ± 10% T_{amb} = 0°C to +70°C C_L = 50pF R_L = 500Ω		V_{CC} = +5.0V ± 10% T_{amb} = −40°C to +85°C C_L = 50pF R_L = 500Ω		
			MIN	TYP	MAX	MIN	MAX	MIN	MAX	
t_{su} (H) t_{su}(L)	Setup time, high or low Jn, Kn to $\overline{CP}n$	Waveform 1	4.0 3.5			5.0 4.0		5.0 4.5		ns
t_h (H) t_h (L)	Hold time, high or low Jn, Kn to $\overline{CP}n$	Waveform 1	0.0 0.0			0.0 0.0		0.0 0.0		ns
t_w (H) t_w (L)	$\overline{CP}$ pulse width, high or low	Waveform 1	4.5 4.5			5.0 5.0		5.0 5.0		ns
t_w (L)	$\overline{SD}n$ pulse width, low	Waveform 2	4.5			5.0		5.0		ns
t_{rec}	Recovery time $\overline{SD}n$ to CPn	Waveform 2	4.5			5.0		5.0		ns

# Dual J-K negative edge-triggered flip-flops without reset

AC WAVEFORMS

For all waveforms, $V_M = 1.5V$.
The shaded areas indicate when the input is permitted to change for predictable output performance.
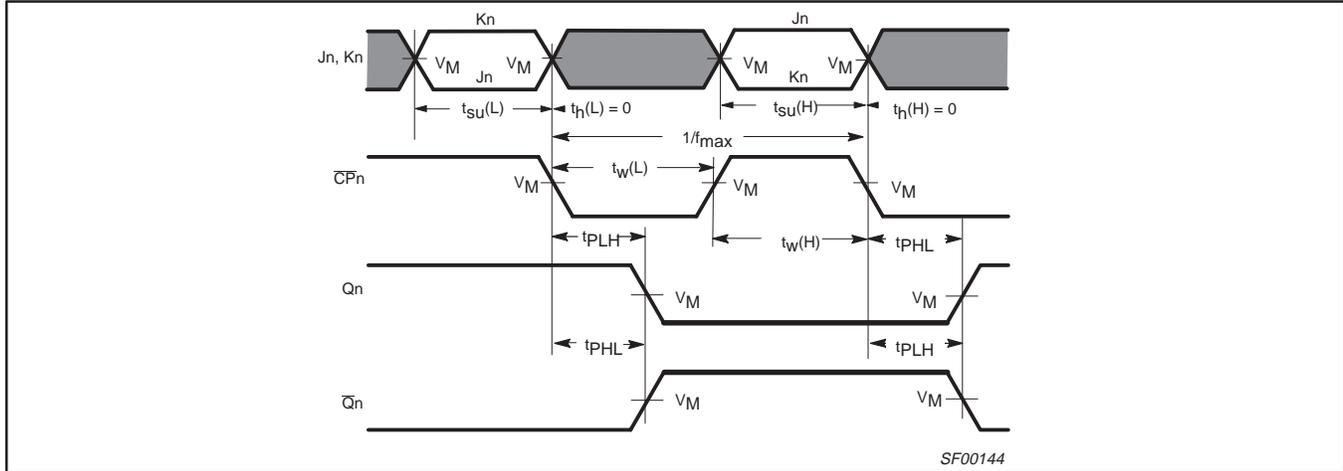
Waveform 1.   Propagation Delay for Data to Output, Data Setup Time and Hold Times, and Clock Width, and Maximum Clock Frequency
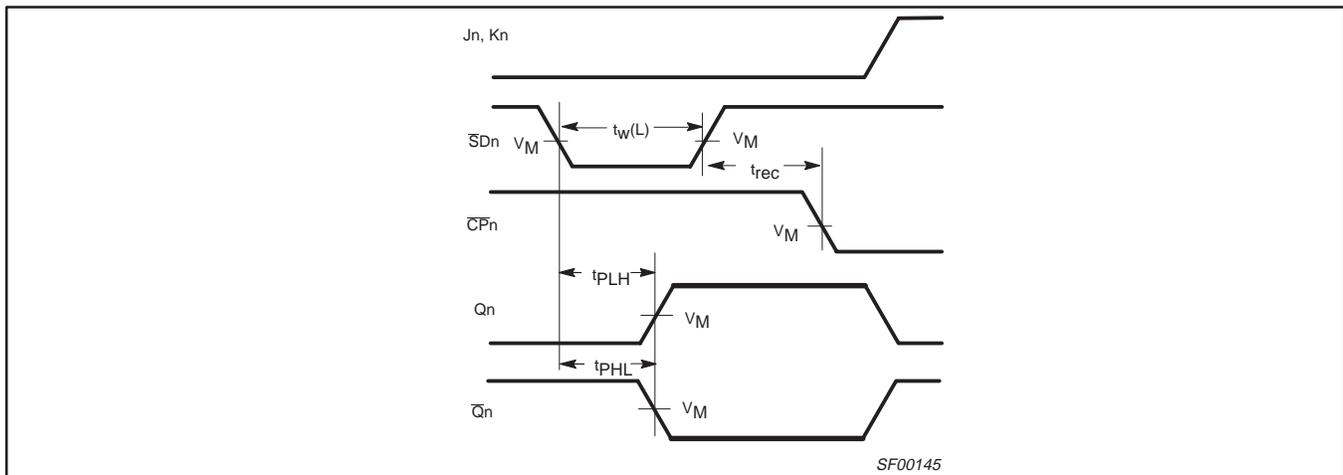

Waveform 2.   Propagation Delay for Set to Output, Set Pulse Width, and Recovery Time for Set to Clock

TEST CIRCUIT AND WAVEFORMS
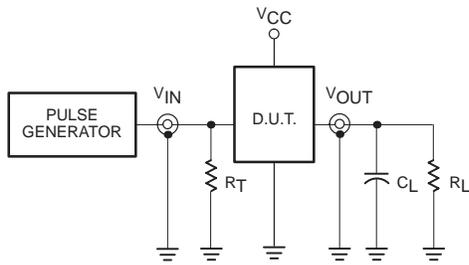
Test Circuit for Totem-Pole Outputs
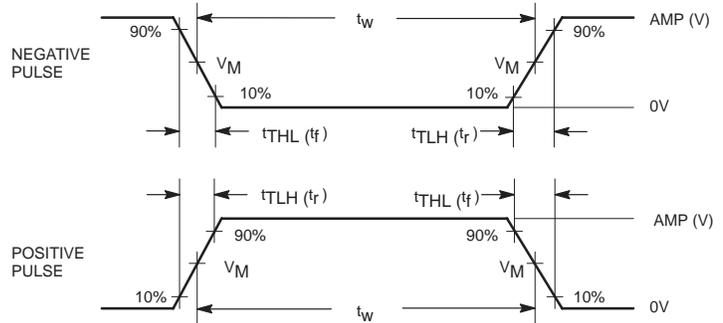
Input Pulse Definition

DEFINITIONS:

R_L = Load resistor;
  see AC ELECTRICAL CHARACTERISTICS for value.

C_L = Load capacitance includes jig and probe capacitance;
  see AC ELECTRICAL CHARACTERISTICS for value.

R_T = Termination resistance should be equal to Z_{OUT} of
  pulse generators.

| family	INPUT PULSE REQUIREMENTS					
	amplitude	V_M	rep. rate	t_w	t_{TLH}	t_{THL}
74F	3.0V	1.5V	1MHz	500ns	2.5ns	2.5ns

SF00006

Dual J-K negative edge-triggered flip-flops without reset

74F113

DIP14: plastic dual in-line package; 14 leads (300 mil)   **SOT27-1**
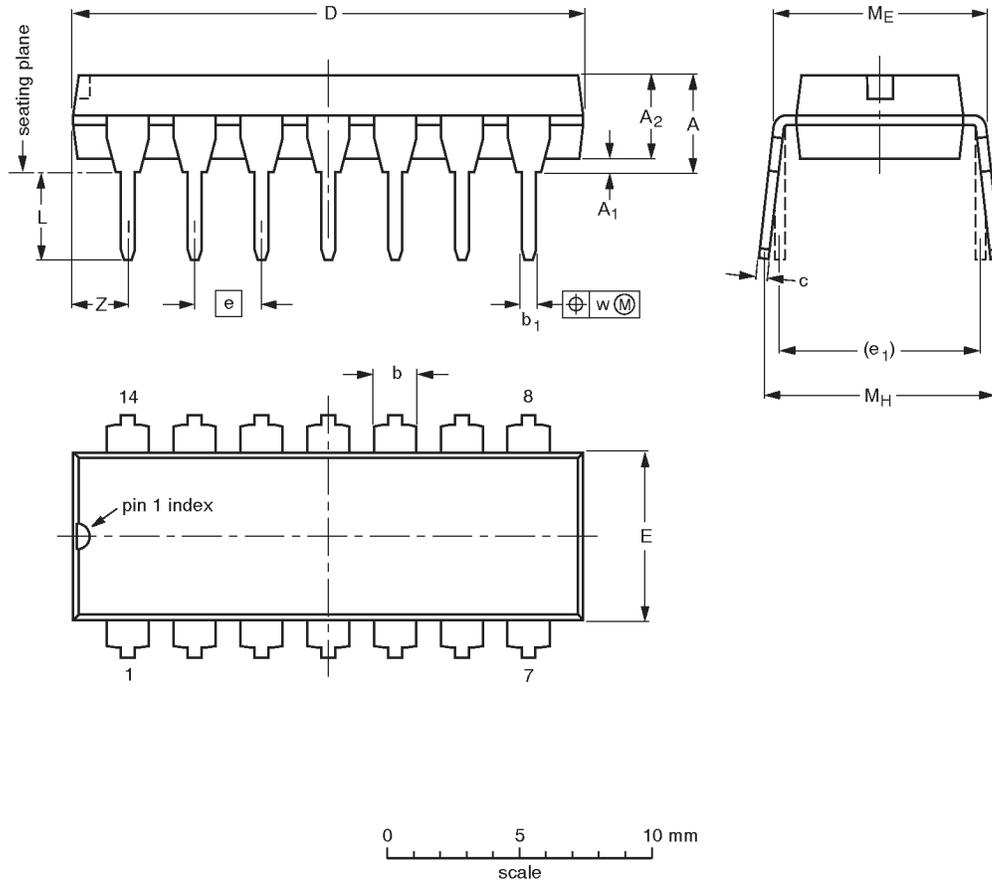
DIMENSIONS (inch dimensions are derived from the original mm dimensions)

UNIT	A max.	A₁ min.	A₂ max.	b	b₁	c	D [1]	E [1]	e	e₁	L	M_E	M_H	w	Z [1] max.
mm	4.2	0.51	3.2	1.73 1.13	0.53 0.38	0.36 0.23	19.50 18.55	6.48 6.20	2.54	7.62	3.60 3.05	8.25 7.80	10.0 8.3	0.254	2.2
inches	0.17	0.020	0.13	0.068 0.044	0.021 0.015	0.014 0.009	0.77 0.73	0.26 0.24	0.10	0.30	0.14 0.12	0.32 0.31	0.39 0.33	0.01	0.087

Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

| OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	**JEDEC**	**EIAJ**			
SOT27-1	050G04	MO-001AA				92-11-17 95-03-11

Dual J-K negative edge-triggered flip-flops without reset

74F113

SO14:   plastic small outline package; 14 leads; body width 3.9 mm

SOT108-1


```
        0       2.5      5 mm
        |_._._._|_._._._|
              scale
```
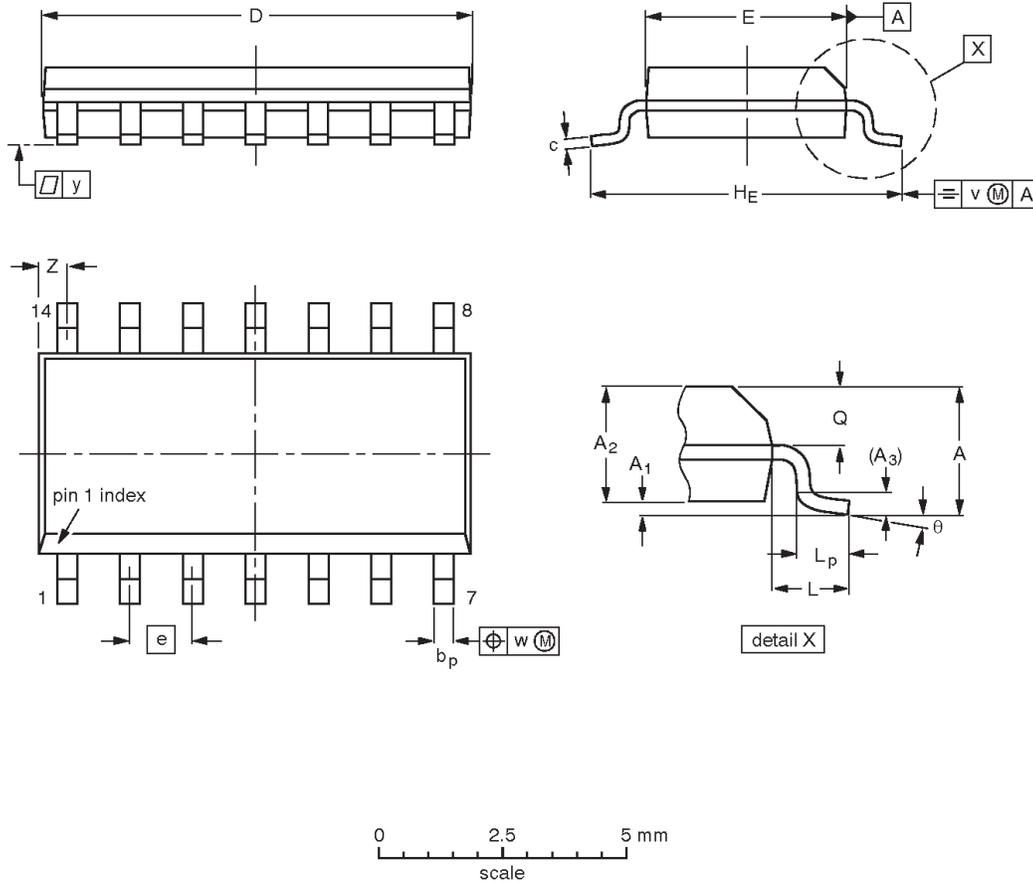
DIMENSIONS (inch dimensions are derived from the original mm dimensions)

UNIT	A max.	A₁	A₂	A₃	bₚ	c	D(1)	E(1)	e	HE	L	Lₚ	Q	v	w	y	Z(1)	θ
mm	1.75	0.25 0.10	1.45 1.25	0.25	0.49 0.36	0.25 0.19	8.75 8.55	4.0 3.8	1.27	6.2 5.8	1.05	1.0 0.4	0.7 0.6	0.25	0.25	0.1	0.7 0.3	8° 0°
inches	0.069	0.010 0.004	0.057 0.049	0.01	0.019 0.014	0.0100 0.0075	0.35 0.34	0.16 0.15	0.050	0.244 0.228	0.041	0.039 0.016	0.028 0.024	0.01	0.01	0.004	0.028 0.012	

Note

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ			
SOT108-1	076E06S	MS-012AB				~~95-01-23~~ 97-05-22

NOTES

Dual J-K negative edge-triggered flip-flops without reset   74F113

Data sheet status

Data sheet status	Product status	Definition [1]
Objective specification	Development	This data sheet contains the design target or goal specifications for product development. Specification may change in any manner without notice.
Preliminary specification	Qualification	This data sheet contains preliminary data, and supplementary data will be published at a later date. Philips Semiconductors reserves the right to make chages at any time without notice in order to improve design and supply the best possible product.
Product specification	Production	This data sheet contains final specifications. Philips Semiconductors reserves the right to make changes at any time without notice in order to improve design and supply the best possible product.

[1]   Please consult the most recently issued datasheet before initiating or completing a design.

Definitions

Short-form specification — The data in a short-form specification is extracted from a full data sheet with the same type number and title. For detailed information see the relevant data sheet or data handbook.

Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

Application information — Applications that are described herein for any of these products are for illustrative purposes only. Philips Semiconductors make no representation or warranty that such applications will be suitable for the specified use without further testing or modification.

Disclaimers

Life support — These products are not designed for use in life support appliances, devices or systems where malfunction of these products can reasonably be expected to result in personal injury. Philips Semiconductors customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify Philips Semiconductors for any damages resulting from such application.

Right to make changes — Philips Semiconductors reserves the right to make changes, without notice, in the products, including circuits, standard cells, and/or software, described or contained herein in order to improve design and/or performance. Philips Semiconductors assumes no responsibility or liability for the use of any of these products, conveys no license or title under any patent, copyright, or mask work right to these products, and makes no representations or warranties that these products are free from patent, copyright, or mask work right infringement, unless otherwise specified.

print code   Date of release: 10-98

Document order number: 9397-750-05072

Let's make things better.

Philips
Semiconductors

PHILIPS